

Unit = III

P.N Junction

Important Energy bands:-

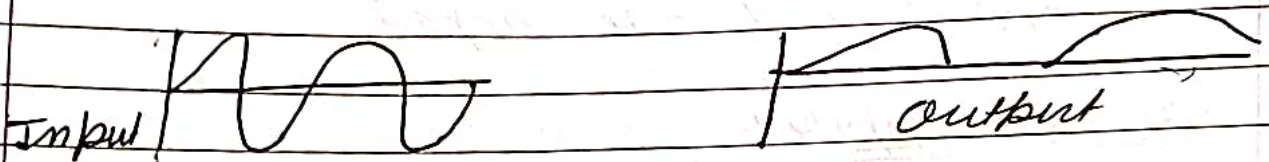
1. > Valance band:- The electrons in the outmost orbit of an atom are known as valance electrons. Under normal condition of the atom valance band contains the e^- of highest energy. This band may be filled completely or partially.
2. > Conduction gap:- In some of the material for example:- metals the valance e^- are attached to the nucleus and can be reattached very easily. These e^- are known as free e^- and are responsible for the conduction of current.
3. > Forbidden energy gap:- The energy gap b/w the valance band and conduction band is known as forbidden energy gap.

HOL :- A vacancy left in the valance band because of lifting of electron from valance band to conduction band is called HOL.

- # ON Current :- The movement of holes (+vely charged vacancy in the valence band) from +ve terminal of the supply to the -ve terminal to semiconductor constitute HOC current.
- # Intrinsic semiconductor :- An extremely pure semiconductor is called intrinsic semiconductor.
- # Extensive semiconductor :- An extremely impure semiconductor is called extensive semiconductor.
- # Drift current :- The flow of current in the semiconductor constituted by the drift of free e^- available in the conduction band and holes available in valence band which are formed due to external energy (Heat supply to them is known as drift current).
- # Doping :- It is a process by which an impurity is added in semiconductor is known as doping. Depending upon the type of impurity adding extensive semiconductor may be classified into 2 types
- 1) N-type
 - 2) P-type

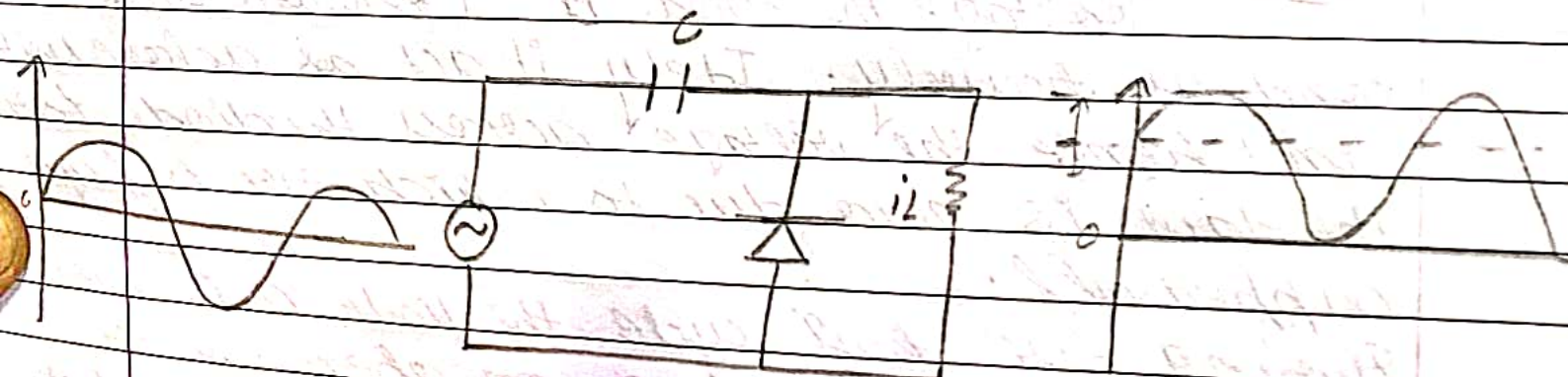
The circuit behaves as voltage divider which the output is taken across R_1 .

Some times it is required to remove the -ve half cycle of the input signal in that case the direction of the polarity of the diode can be i.e. the change such type of clipper is known as -ve clipper.



⇒ Clamper:- A circuit which shifts either +ve or -ve peak of the signal desired DC level is known as clamping circuit or clamper.

Positive clamper:- A circuit which shifts the signal in the +ve side in such a way that the -ve peak of the signal falls on the zero level is called +ve clamper.



N-type Semiconductor:-

When a small amount of pentavalent impurity is added to a pure semiconductor providing a large no of free e^- in it is known as N-type semiconductor.

P-type Semiconductor:- When a small amount of trivalent impurity is added to a pure semiconductor providing a large number of holes it is known as p-type semiconductor.

Hence, in N-Type semiconductor e^- are majority where as holes are minority carriers.

⇒ PN JUNCTION:-

When a P-type semiconductor is joined to an N-type semiconductor the contact surface is known as PN Junction.

Formation of PN Junction:-

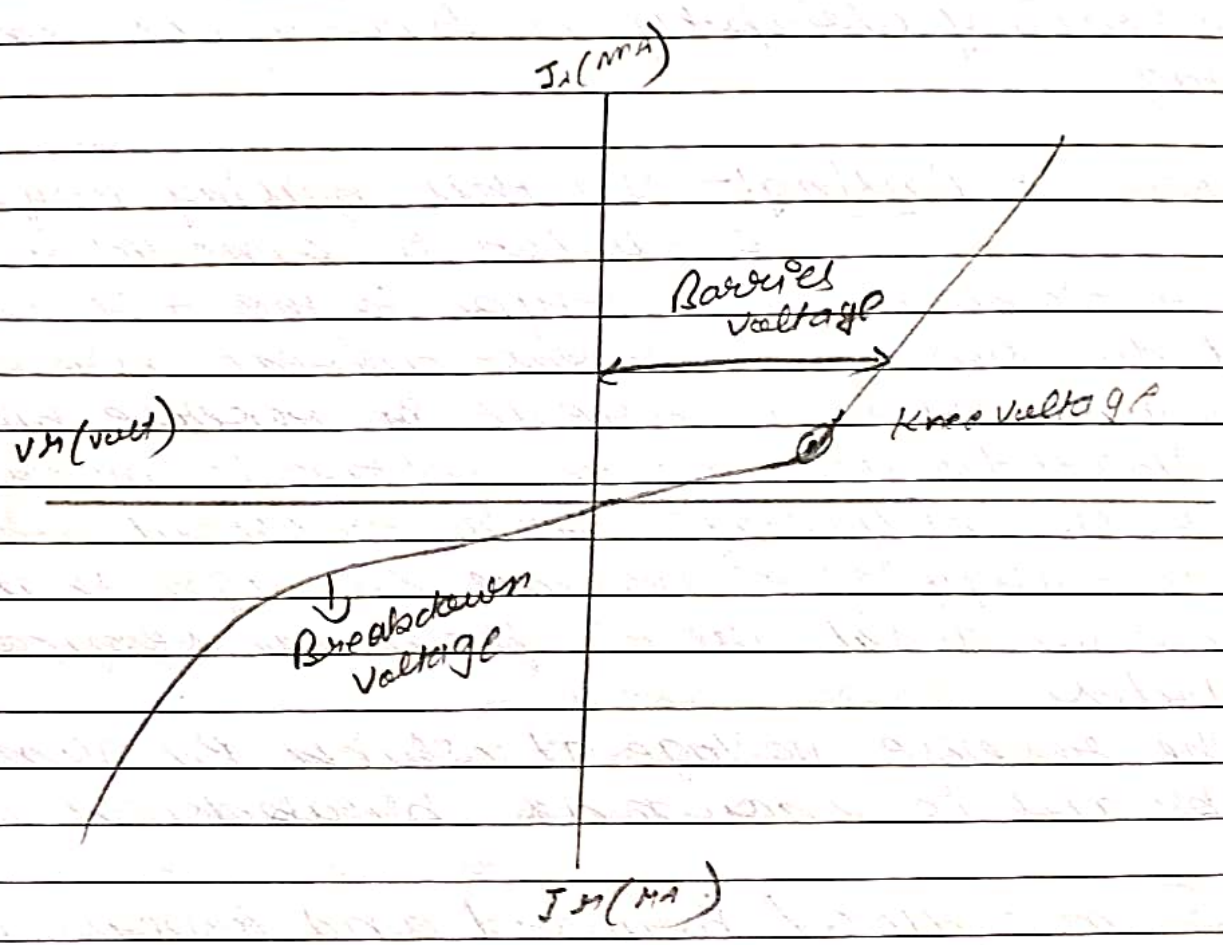
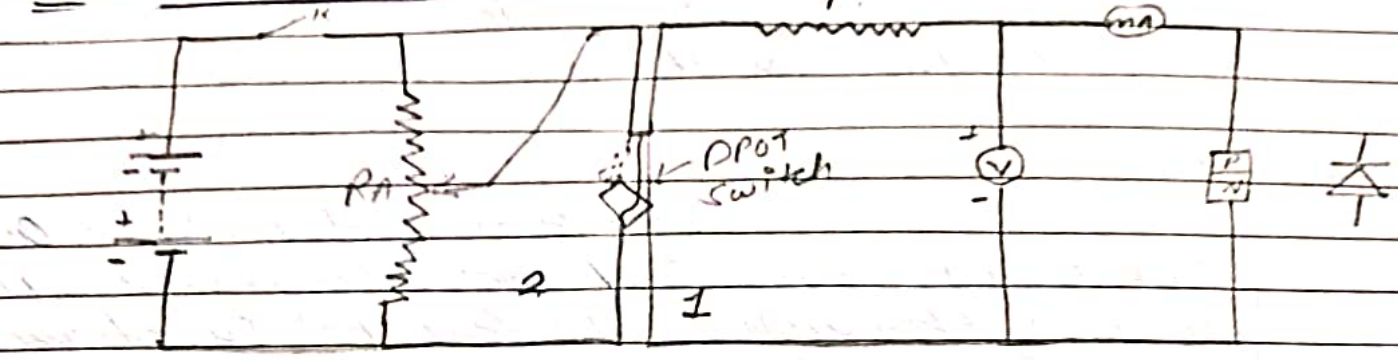
An PN Junction is fabricated by special technique known as alloying and diffusion method. An alloyed junction is made from an N-type slice of semiconductor (germanium or silicon) by melting a pellet of trivalent indium piece on the slice. This is done by heating the system to about 500°C or higher. The indium is absorbed into the germanium.

In this mechanism electric field existing in the depletion layer is sufficiently high the velocity of carriers crossing the depletion layer increases. The carriers collide with the crystal atoms and create e^- hole pairs. As the pair of e^- is created in the mid of the high field they quickly separate and attain high velocity to cause further pair generation through more collisions. It is a continuous process and as it approaches the breakdown voltage the field becomes so large that the chain of collision can give rise to an almost infinite current with very little additional increasing voltage.

It takes place in a very thin junction that is when both sides of the junction are ~~even~~ heavily doped and the depletion layer is narrow. In the breakdown electric field becomes high and with only a small applied reverse bias voltage multiplication breakdown takes place.

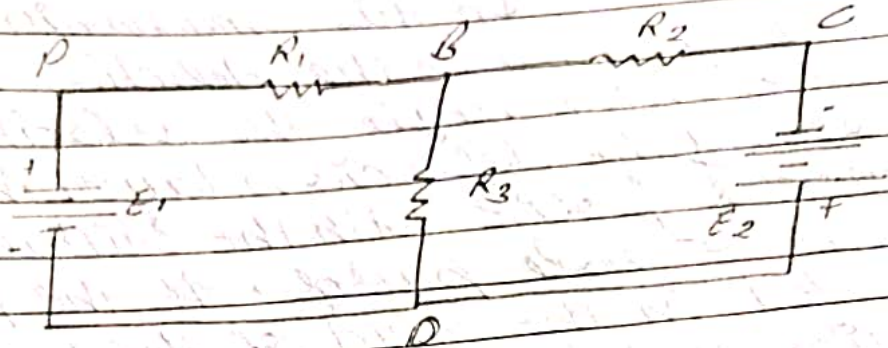
of silicon to produce a p region and hence a PN Junction is form.

VI Characterstics of PN Junction:-



Network Anal:-

Act



Active Element:- The element which supply energy to the circuit is called active element. E_1 & E_2 are active elements.

Passive element:- The element which receive energy is called passive element (resistor, inductor, and capacitor).
In Fig = 1 R_1, R_2, R_3 are the passive elements.

Node:- A node is a point in the network where two or more circuit elements are join.

Junction:- A junction is a point in the network where 3 or more circuit elements are join. In fact it is a point where current is divided (B & D).

Branch:- The part of a network which lies b/w two junction point is called branch.

Forward Biasing :-

When key (K) is closed and double through switch is on position 1 the PN Junction is forward bias as P-type semiconductor is connected to the +ve terminal and N-type to the -ve terminal of the supply.

Knee Voltage :-

The forward voltage (0.3 volt for germanium, 0.7V for silicon). At which the current through diode for PN Junction start increasing abruptly is known as knee voltage.

Reverse Biasing :-

In this biasing P-type semiconductor is connected to the +ve terminal and N-type to the -ve terminal of the supply. The reverse current increases slightly with the increase in reverse bias supply voltage. In the reverse voltage is increase consistently a stage which reach out when kinetic energy of e^- become so high that they knock out the e^- from the semiconductor.

The reverse voltage at which PN Junction breaks is known as breakdown voltage.

★ Summary of Forward and Reverse Biasing :-

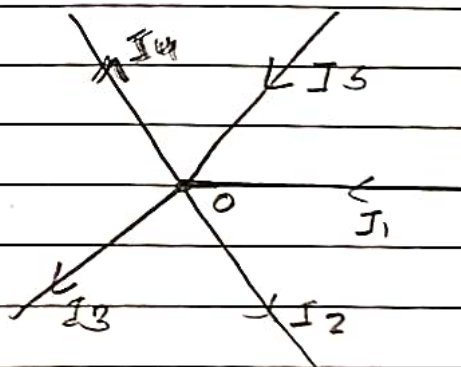
From the above discussion it may be noted that :-

Loop:- The cross path of a network is called loop. $ABDA$, BCD

Mesh:- The most elementary form of a loop which cannot be further divided is called mesh.

Kirchoff's law:-

First law:- This law relates the current flowing to the circuit is known as Kirchoff current law (KCL). This law states that the algebraic sum of all the currents meeting at a point or junction is zero.



In this incoming current in fig 2 is taken as +ve and outgoing current is taken as -ve

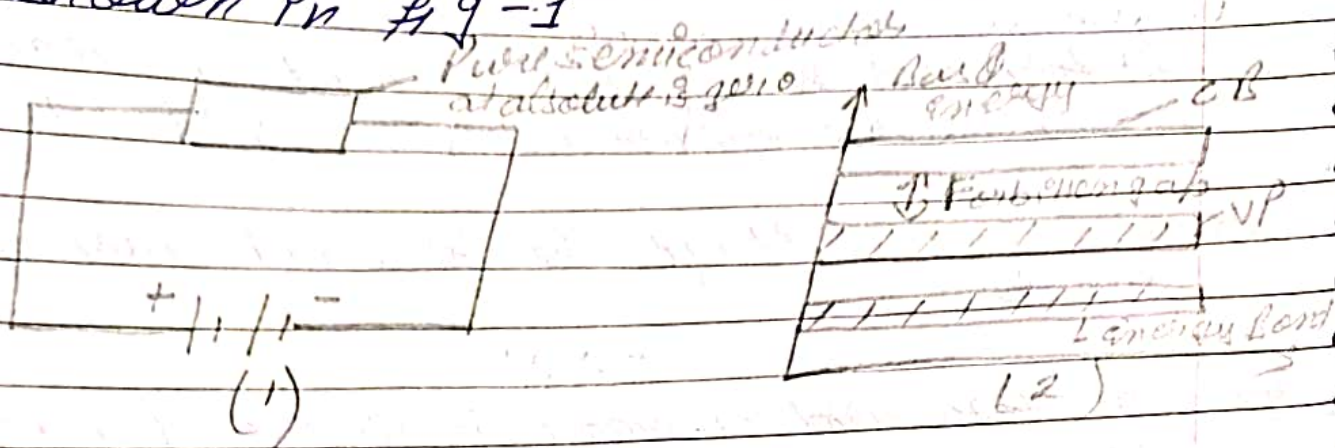
$$I_1 + I_5 + I_3 = I_4 + I_2$$

- 1.) At zero external voltage no current flow the circuit or diode.
- 2.) At forward bias the current increases slightly till the barrier voltage is achieved
- 3.) After knee voltage the forward current rises abruptly.
- 4.) The forward current is limited by series resistance.
- 5.) In reverse bias the reverse current increases slightly with the increasing voltage. For silicon diode the maxi. value of reverse current is 1 mA . However for germanium this value is 100 mA .

Effect of temp. on the conductivity of semiconductor diode:-

→ AT absolute zero:- temp. all the electrons of semiconductors are held tightly in the atoms. The inner orbitals are bound to nucleus whereas the valance electrons are bound by the forces of covalent bonds. Therefore at this temperature no e^- is available in the semiconductor. The semiconductor crystal behaves like perfect insulator.

Know if some potential differences applied across the semiconductor as shown in fig-1



The behaviour of a semiconductor at absolute zero temp. can be explained with the help of energy band as shown in fig 2. The valance band at absolute zero temp. is completely filled whereas the conduction band is totally empty moreover no valance e^- can reach the conduction band to become free since no energy is supply to the semiconductor crystal and they cannot cross the forbidden energy gap. Hence the semiconductor (SC) behaves as an insulator due to empty conduction band.

→ Above absolute zero :- When the temp. of semiconductor it raised the sum of its covalent bond breaks due to the thermal energy supplied to it. The breaking of bonds set these free e^- which are engaged in the formation of

these bond hence at higher temp a few free e^- exist in semiconductor and they are no longer behave as insulator (SC)

When temp. of SC is increased the heat energy supply to it we left some of the balance e^- to the conduction band. the higher \rightarrow temp. the greater the no. of valance e^- burst up to the conduction band and lower the current and it can conduct.

Transistor :- It is a semiconductor device consist of two PN Junction formed by merging either P type or N-type semiconductor. A pair of opposite type is known as transistor. There are two types of transistor NPN & PNP

NPN Transistor :- A transistor in which two blocks of N-type semiconductor are separated by thin layer of P-type semiconductor is known as transistor.

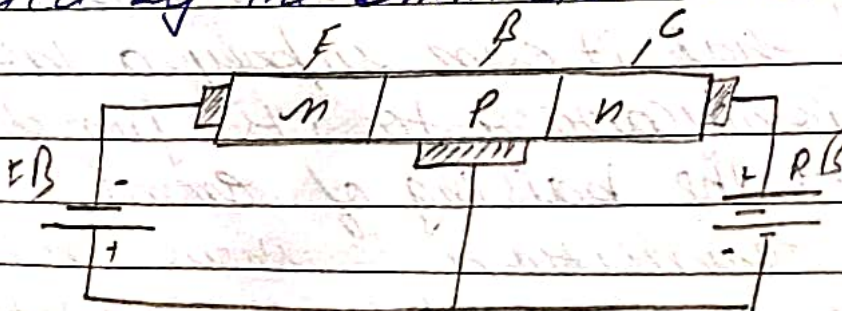
1) Emitter :- It supplies a large no. of major carrier and is called emitter. It is always forward biased with respect to base so that it can supply a large number of majority carrier to its junction with the base. The biasing of emitter based junction of NPN transistor is shown in Fig 1. Since emitter is to supply or inject a large

majority carriers into the base it is heavily doped but moderate in size.

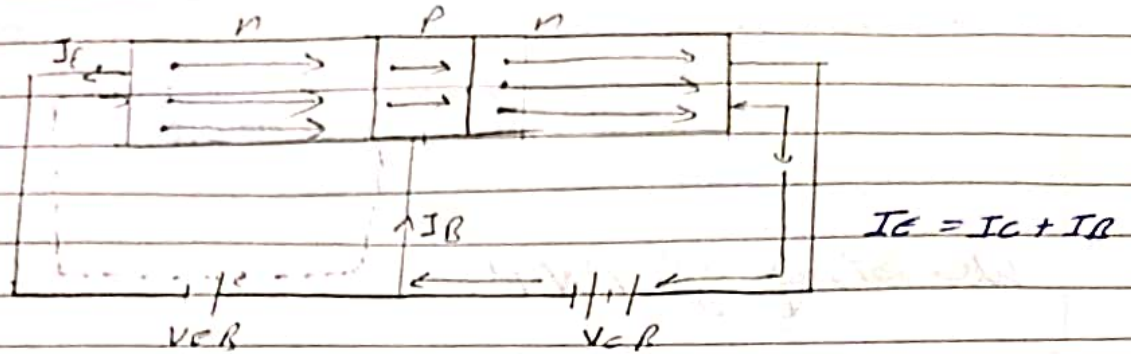
Collector :- Its main function is to collect the measure function of the majority carriers supplied by the emitter is called collector. This junction is always reverse biased and its main function is to remove majority carriers from the junction with the base. The collector is moderately doped but large in size so that it can collect most of the majority carriers of emitter.

Base :- The middle section which forms two PN Junction b/w emitter and collector is called base. The base forms two circuit one input circuit with emitter and the other output circuit with the collector. The base emitter junction is forward biased providing low resistance for the emitter.

The base collector junction is reverse biased offering high resistance path to the collector circuit the base is lightly doped and very thin so that it can pass on most of the majority carriers supplied by the emitter to the collector.



Working of an NPN Transistor:-



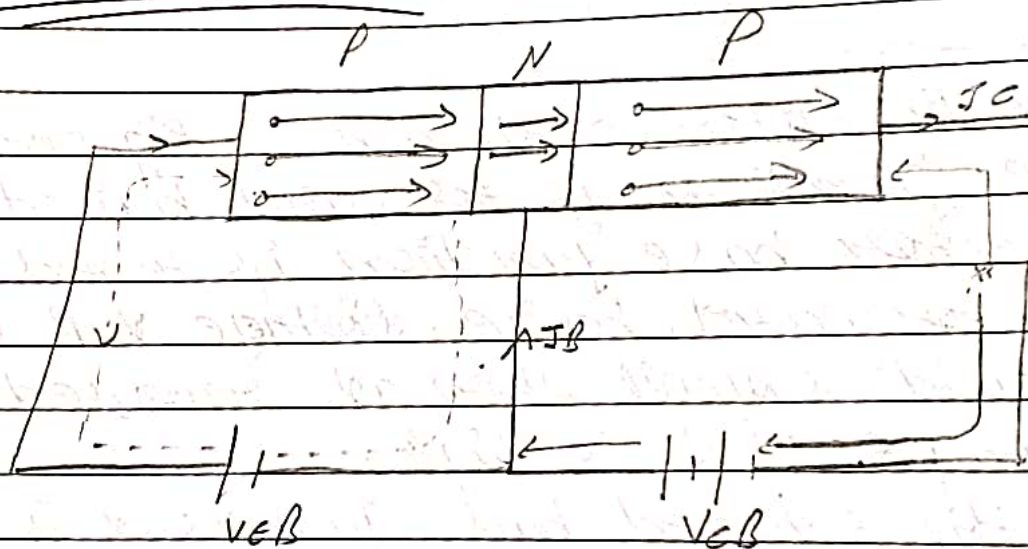
NPN Transistor is shown in Fig. one. The emitter base junction is forward biased while collector base junction is reverse biased. The forward bias voltage V_{EB} is quite ~~small~~ small where as reverse biased voltage V_{CB} is high.

As the emitter base junction is forward biased a large no of e^- (majority carriers), in the emitter n-type region are pushed towards the base due to which emitter current I_E flows. When these e^- enter the p-type material (base) they try to combine with the holes. Since the base is ^{thin} and very thin only a few e^- only combine with the holes constitute the base current I_B (only 5%). The remaining e^- the ~~free~~ diffuse across the thin base region and reach the collector space charge layer. These e^- then come under the influence of ^{the} reverse biased ~~and~~ n region and are attracted or collected by the collector which helps it.

the flow of current that is I_C . Hence it is observed that the almost entire ~~emitted~~ ^{emitted} current flows in the collector circuit.

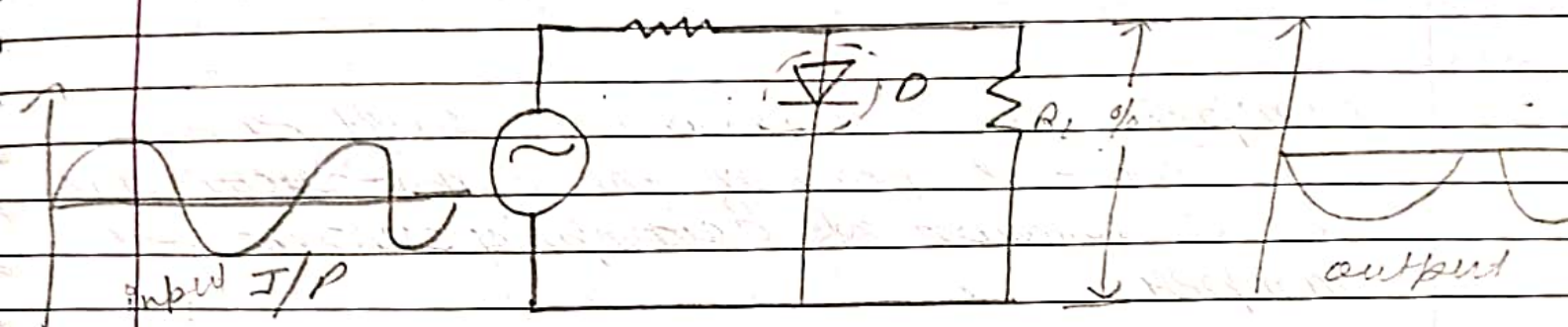
$$I_E = I_C + I_B$$

Working of PNP:-



Clipper:- It is a circuit use to change the shape of an input voltage wave by clamping or removing a portion of it is called clipper circuit. It is also known as clipper/limiter or slicer. A clipper has the ability to remove signals voltage above or below a specified level and hence change the wave shape of input signal. Based on it they are of two types +ve clipper and -ve clipper.

Positive clipper:-



A circuit which remove +ve half cycle of the signal (input voltage) is called +ve clipper.

Working:- During +ve half cycle of input voltage the diode 'D' is forward biased and conducts heavily. Ideally it act as a closed switch and hence the voltage across the diode for the time is zero due to which +ve half cycle is clipped off.

During -ve half cycle the diode D is reverse biased and behave as an open switch. The current flow through R_1 and R which are connected in series. In this condition +ve half cycle is clipped off.